

PATENT Atty. Docket No. 29347/990488

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Jeun et al. I hereby certify that this paper is being deposited with the United States Postal Serial No.: 09/677,558 Service as first class mail, postage prepaid, in an envelope addressed to: Filed: September 29, 2000 Commissioner for Patents, Washington, For: Semiconductor Power Module D.C. 20231, on: Having an Electrically Insulating Heat Sink and Method of Manufacturing the Date: February 6, 2002 Same Group Art Unit: 2814 Examiner: DiLinh Nguyen Reg. No. 28,491 **RESPONSE** 

Commissioner for Patents Washington, DC 20231

Sir:

In response to the official action mailed on November 7, 2001, please consider the accompanying remarks.